ACKNOWLEDGEMENT RECEIPT

Electronic Version 1.1

Stylesheet Version v1.1.1

Title of Invention

Elimination of RDk Using Tape Base Flip Chip on Flex for Die Stacking

Submision Type: Information Disclosure

Statement

Application Number:

10/050507

EFS ID: 97664

Server Response:

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ISVR1	Submission was successfully submitted - Even if Informational or Warning Messages appear below, please do not resubmit this application
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First Named Applicant: Teck Lee
Attorney Docket Number: MTI-31607

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File Listing:

Doc. Name	File Name	Size (Bytes)	Date
			Produced
			(yyyymmdd)
us-ids	MTI-31607b-usidst.xml	1209	2005-11-25
us-ids	us-ids.dtd	7763	2005-11-25
us-ids	us-ids.xsl	12026	2005-11-25
package-data	MTI-31607b-pkda.xml	1733	2005-11-25
package-data	package-data.dtd	27025	2005-11-25
package-data	us-package-data.xsl	19263	2005-11-25
Total files size		69019	

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